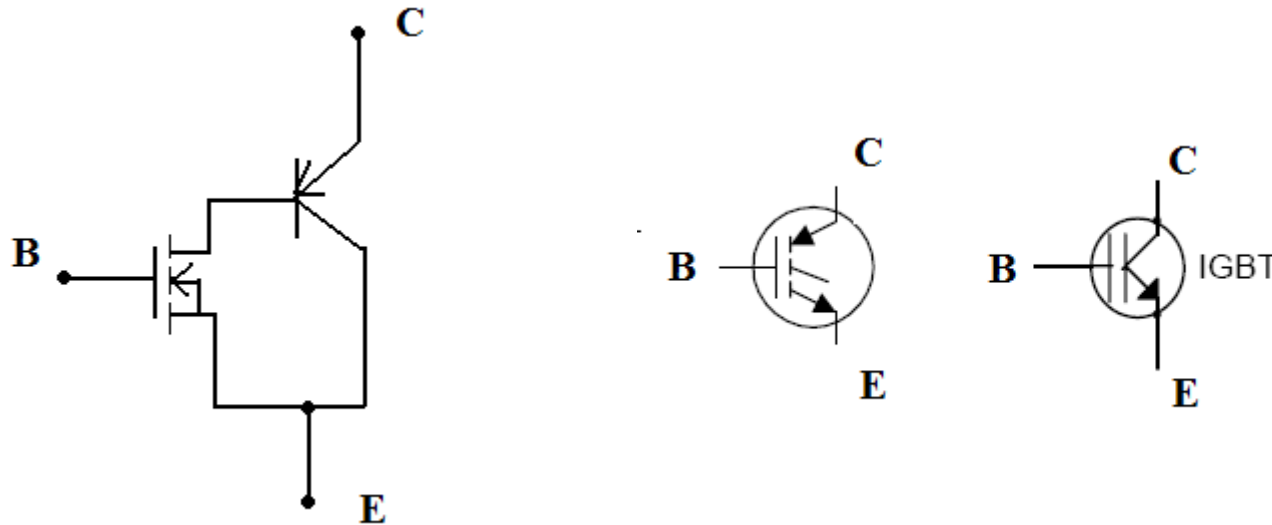


IGBT tranzistory



- používají se jako výkonové spínací prvky do frekvencí 50-100 kHz
- mají výhody tranzistorů MOSFET z hlediska vstupu a výhody BJT z hlediska výstupu
- mají delší spínací časy než MOSFET

Vnitřní struktura IGBT (PT & N-Channel)

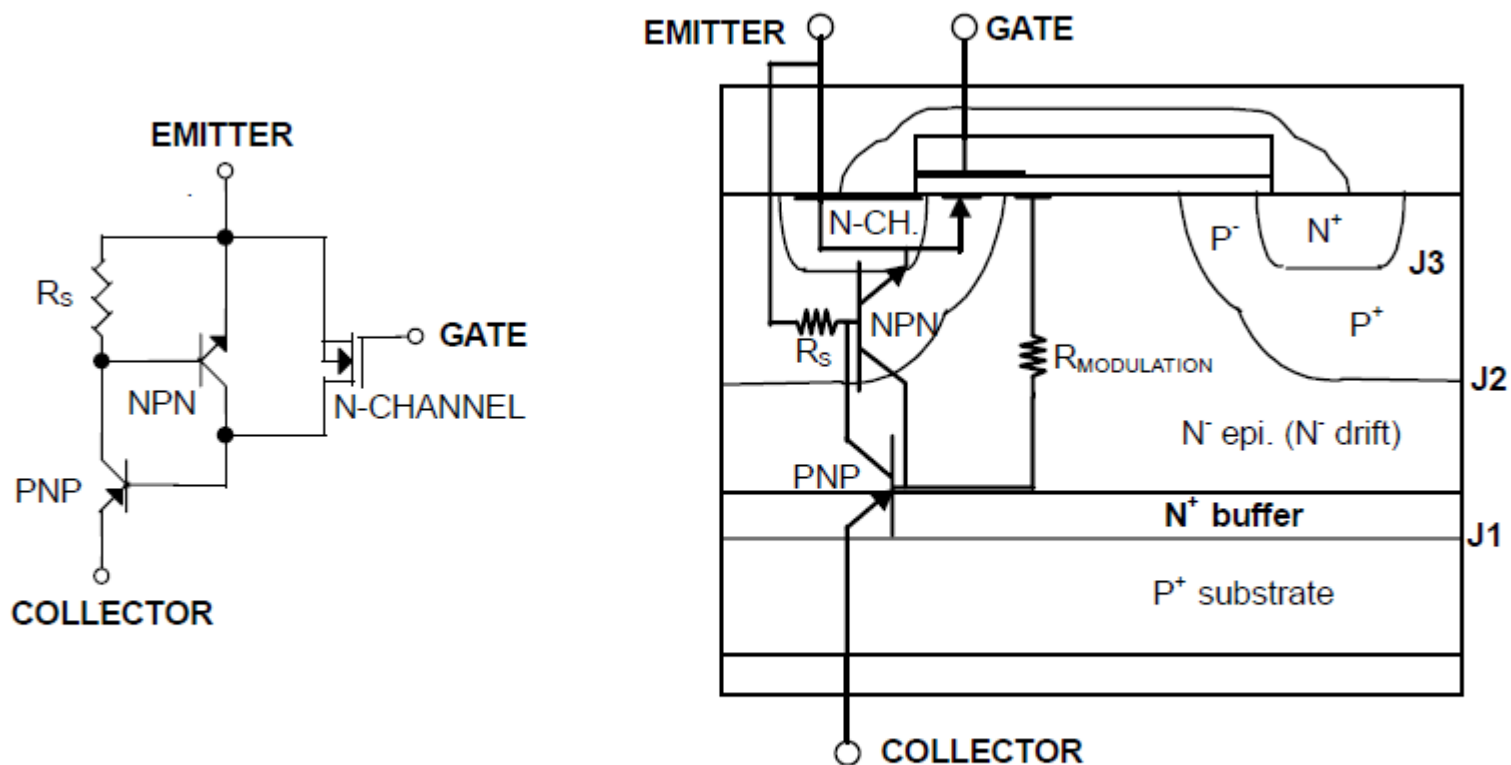


Figure 1. Equivalent Circuit for the IGBT & a Cross Section of the IGBT Structure (PT & N-Channel)

Vnitřní struktura IGBT (NPT) tranzistoru

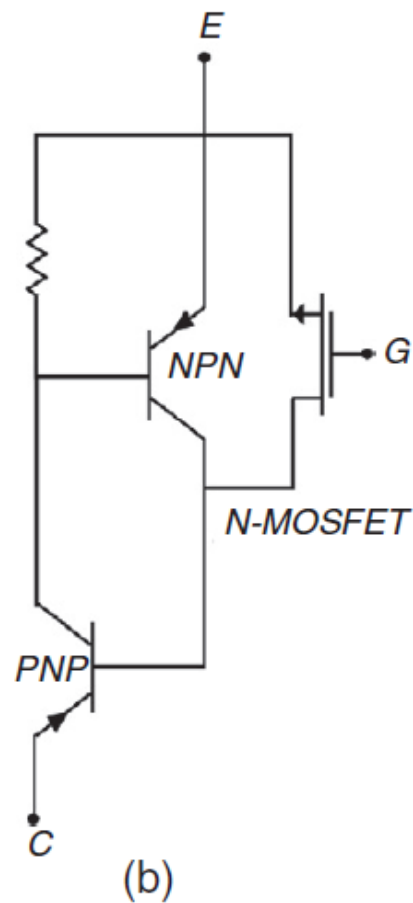
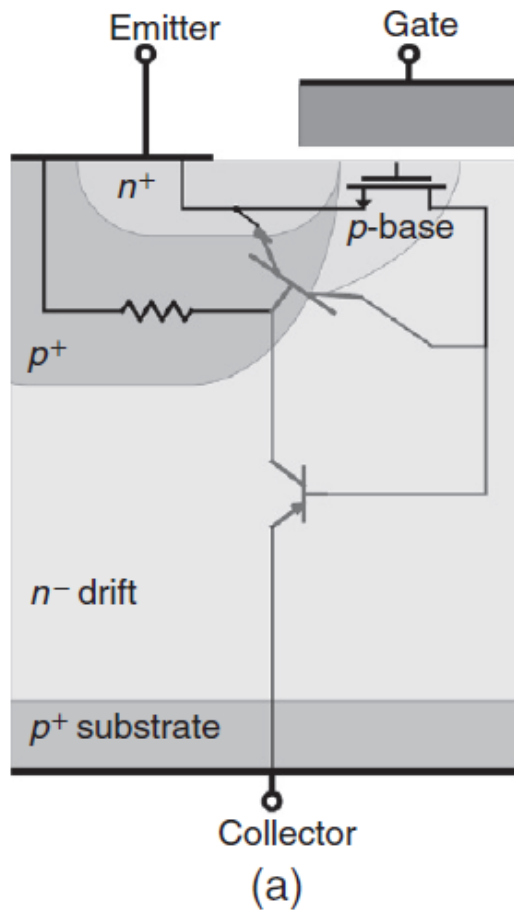
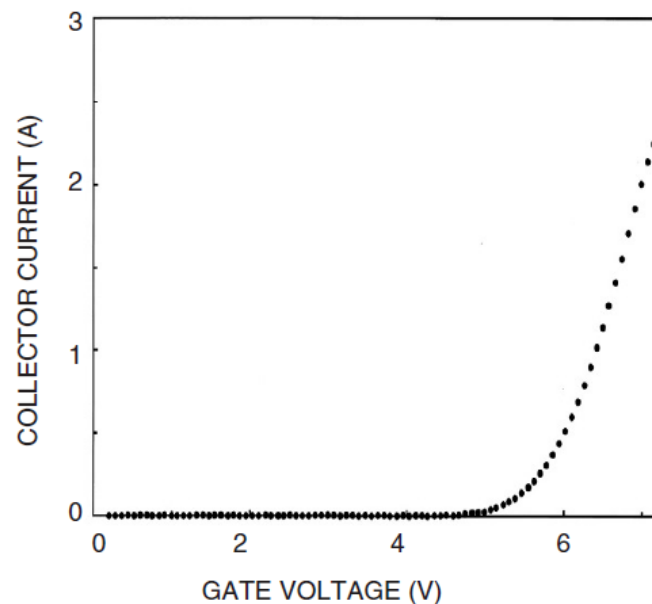
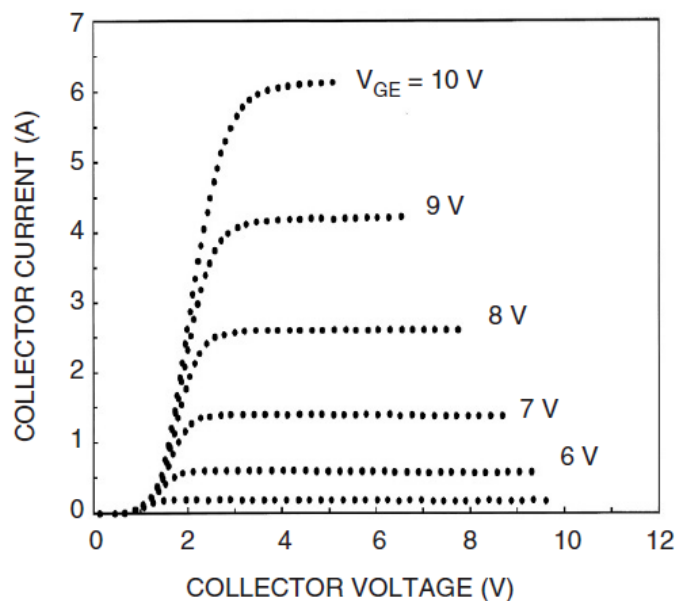


FIGURE 5.2 IGBT: (a) half-cell vertical cross section and (b) equivalent circuit model.

Výstupní a převodní charakteristiky IGBT tranzistoru



Doba života minoritních nosičů v N^- driftové oblasti (bázi PNP) musí být co nejdelší, aby byl co nejmenší spád napětí na tranzistoru v otevřeném stavu. Pak ale při vypnutí tranzistoru bude déle klesat koncentrace nosičů v N^- driftové oblasti a tranzistor bude pomalejší.

PT IGBT (punch through)

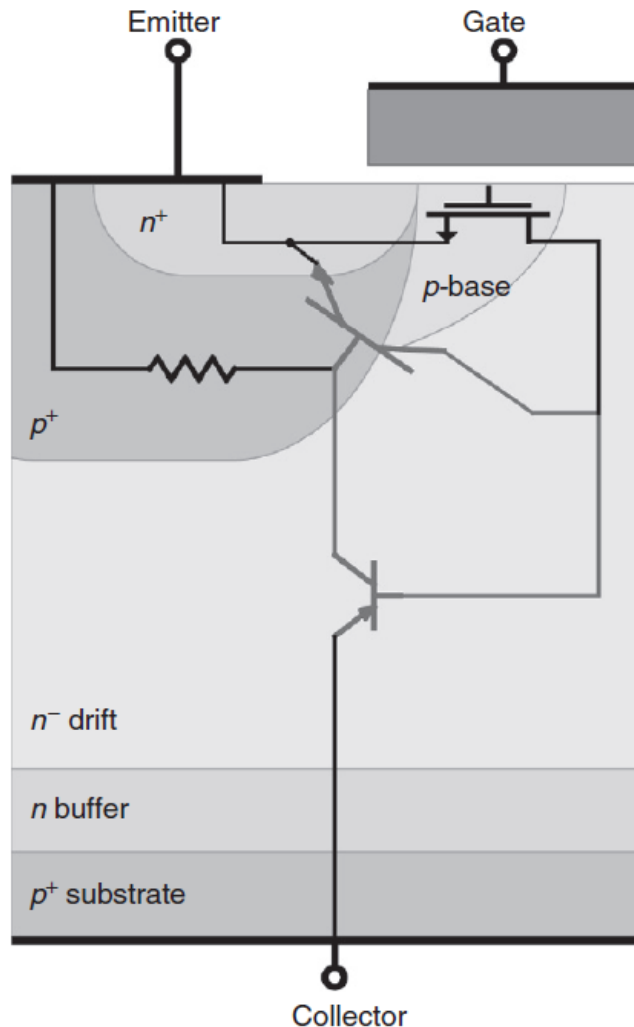
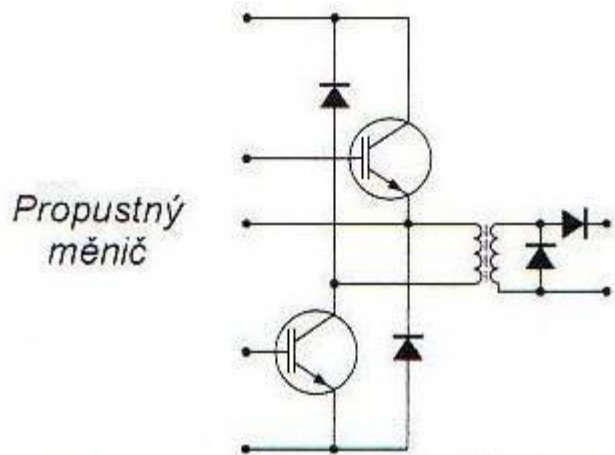


FIGURE 5.4 Punch-through (PT) IGBT structure.

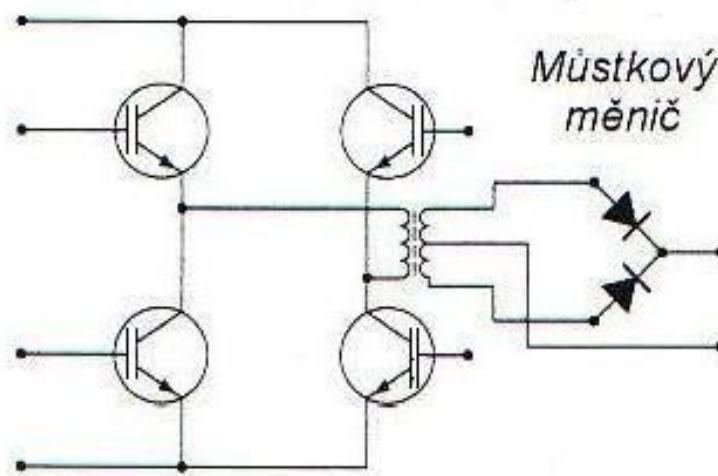
- u kolektoru je silně dopovaná vrstva N, která urychlí rekombinaci přebytečných děr (sníží injekci minoritních nosičů z kolektoru do báze)
- PT- IGBT rychleji vypíná, ale má vyšší napětí mezi CE v sepnutém stavu
- PT IGBT vydrží v opačném směru pouze malé napětí

Aplikace IGBT ve spínaných zdrojích s velkým výkonem

spínané zdroje: zdroje pro PC, svářecí invertory, zdroje plazmatu atd.



malé výkony



velké výkony

Porovnání velikosti úbytku napětí na IGBT a POWER MOSFET v sepnutém stavu

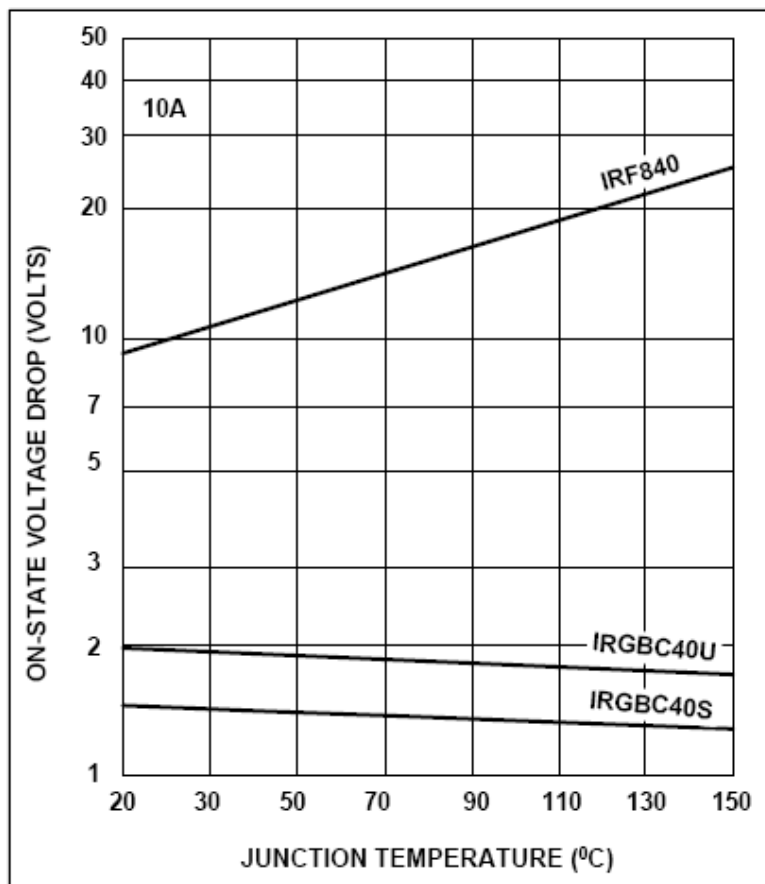


Figure 2. On-state voltage drop as temperature of two IGBTs of different switching characteristics compared to those of a HEXFET of the same die size (IRGBC40S and IRGBC40U vs IRF840). Conductivity modulation causes a dramatic improvement in the on-state voltage drop. To take the avalanche capability of the HEXFET into account, a 500V device is compared with 600V IGBTs.

Rated Voltage	IGBT	100	300	600	1200
	HEXFET®	100	250	500	1000
Typical Voltage Drop @ 1.7A/mm ² , 100°C	IGBT	1.5	2.1	2.4	3.1
	HEXFET®	2.0	11.2	26.7	100

Table 1: Dependence of Voltage Drop From Voltage Rating

Spínací vlastnosti IGBT tranzistorů

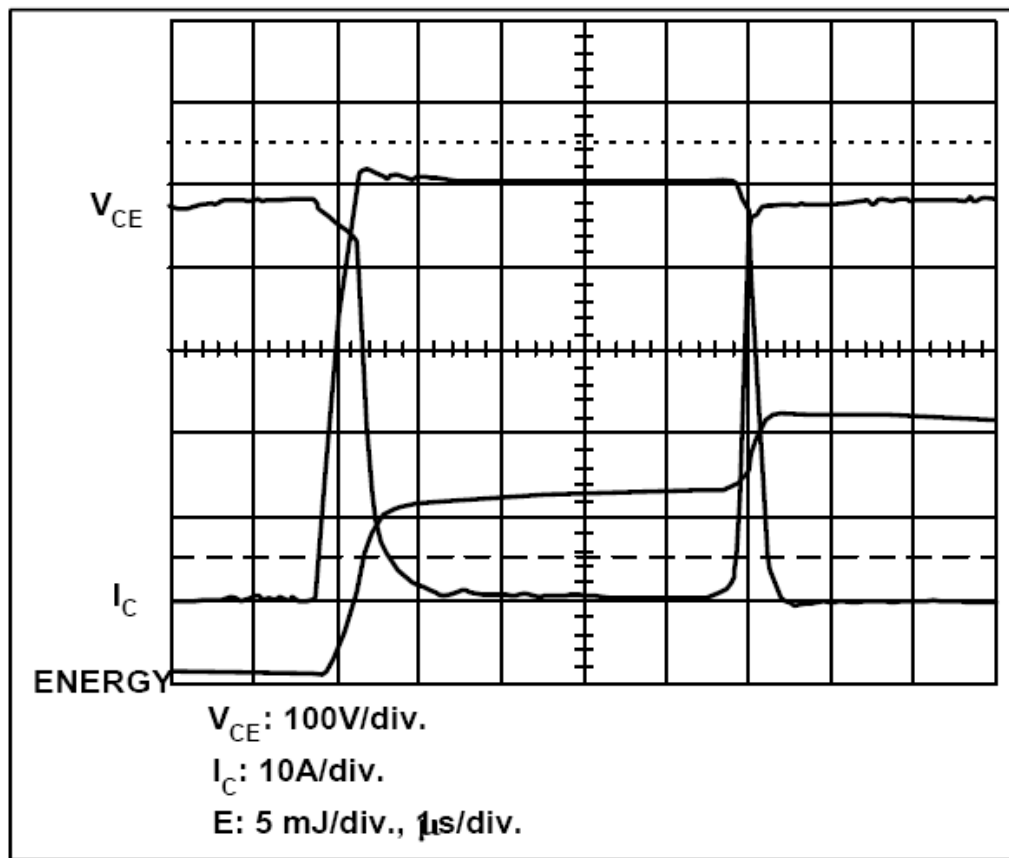


Figure 4. Switching waveforms of a commercially available IGBT with heavy lifetime killing. It takes approximately 0.5ms for the voltage to drop the last 50V. The energy plot shows that the losses at turn-on are twice as high as those at turn-off. Switching circuit as in Figure 16.

Porovnání strmosti IGBT a MOSFET

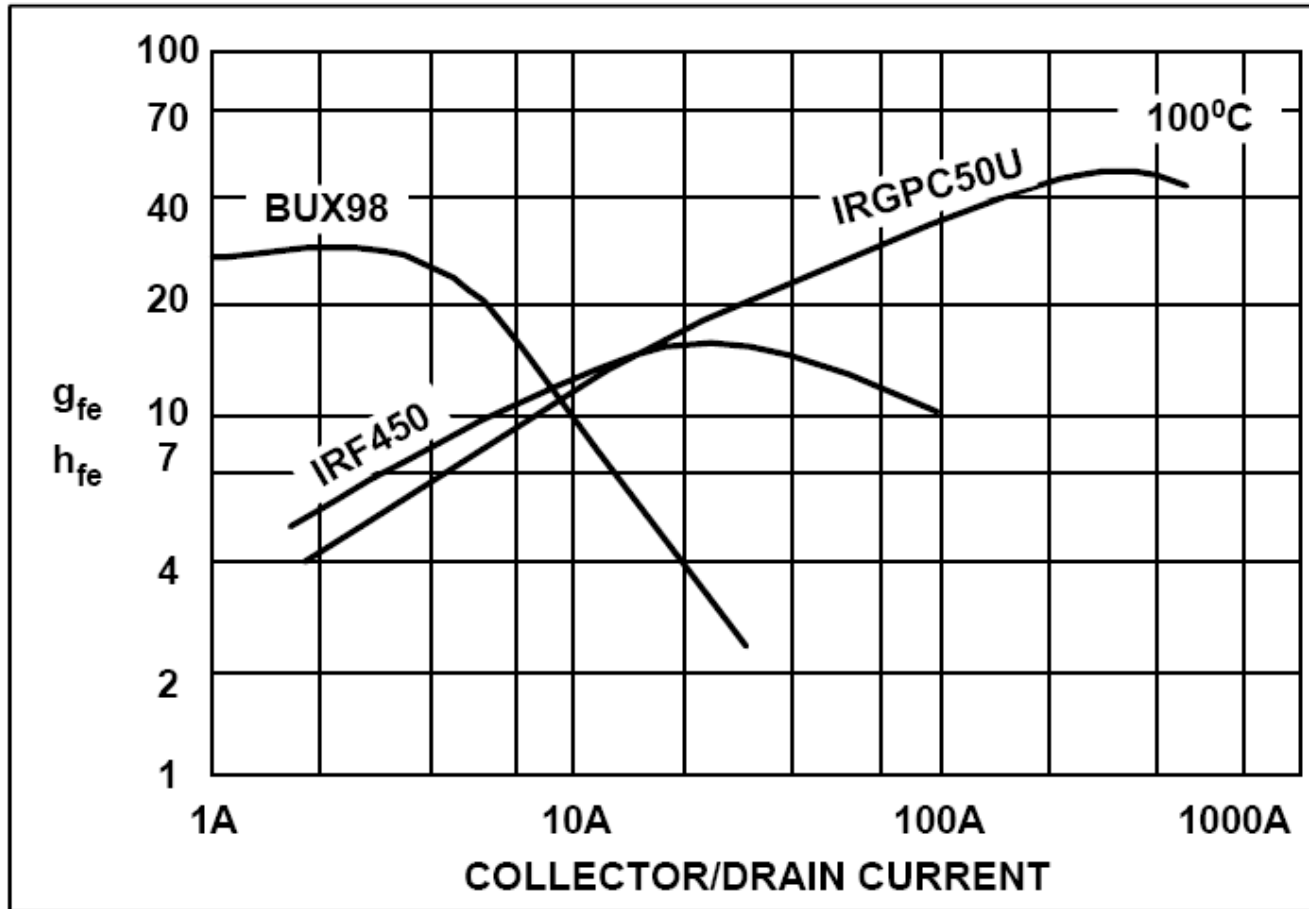
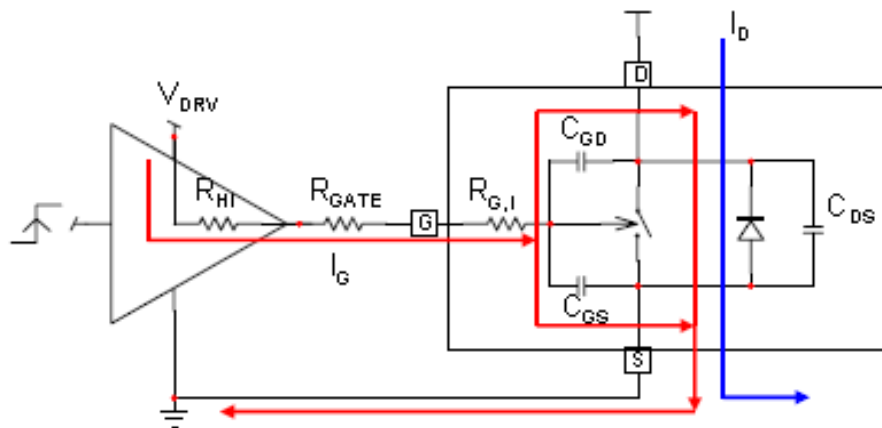


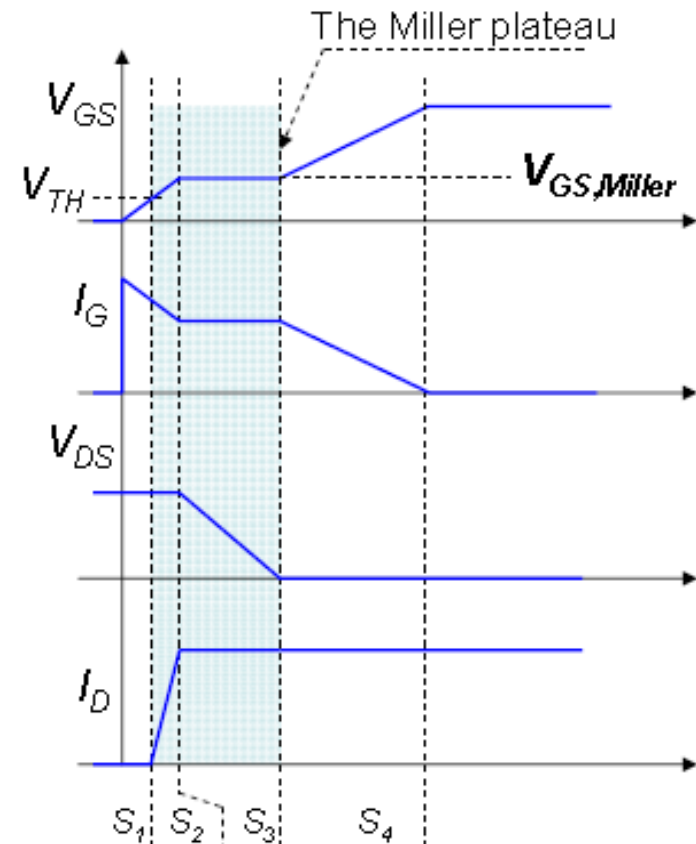
Figure 5. Current dependence of the transconductance of an IGBT compared to that of a HEXFET and to the gain of a bipolar of approximately the same die size. The IGBT, like the power MOSFET, is not "gain limited."

Rychlé skokové “tvrdé spínání MOSFET nebo IGBT spínače”

Turn-on Procedure for Hard-switching



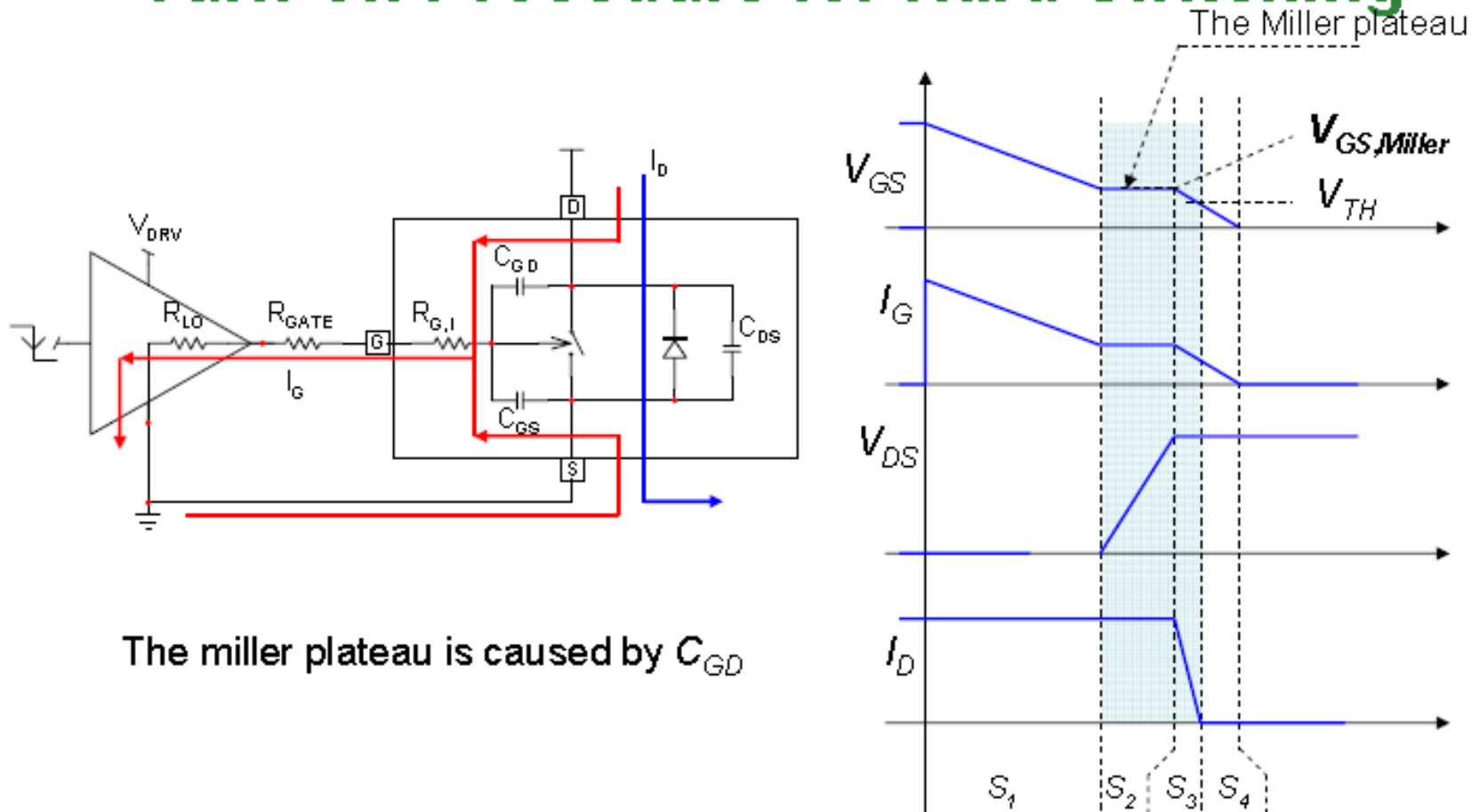
The miller plateau is caused by C_{GD}



- Stages 2 and 3 dominate the switching losses of MOSFET and driver.
- DRV's source capability as V_{GS} is around $V_{GS, Miller}$ is important.

“Tvrdé” skokové vypínání

Turn-off Procedure for Hard-switching

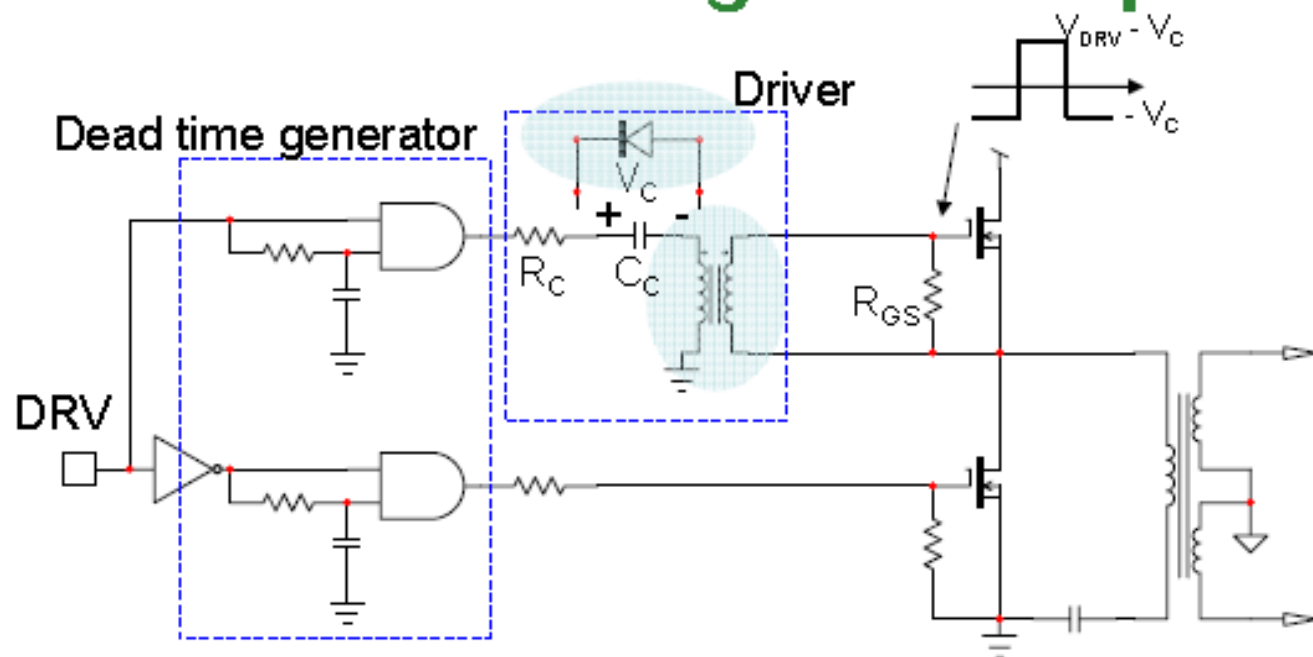


The miller plateau is caused by C_{GD}

- Stages 2 and 3 dominate the switching losses of MOSFET and driver.
- DRV's sink capability as V_{GS} is around $V_{GS,Miller}$ is important.

Buzení MOSFET nebo IGBT přes oddělovací transformátor

Single DRV Input



$$V_C = DV_{DRV}$$

$$Q > \frac{1}{R_C} \sqrt{\frac{L_M}{C_C}} = 0.5$$

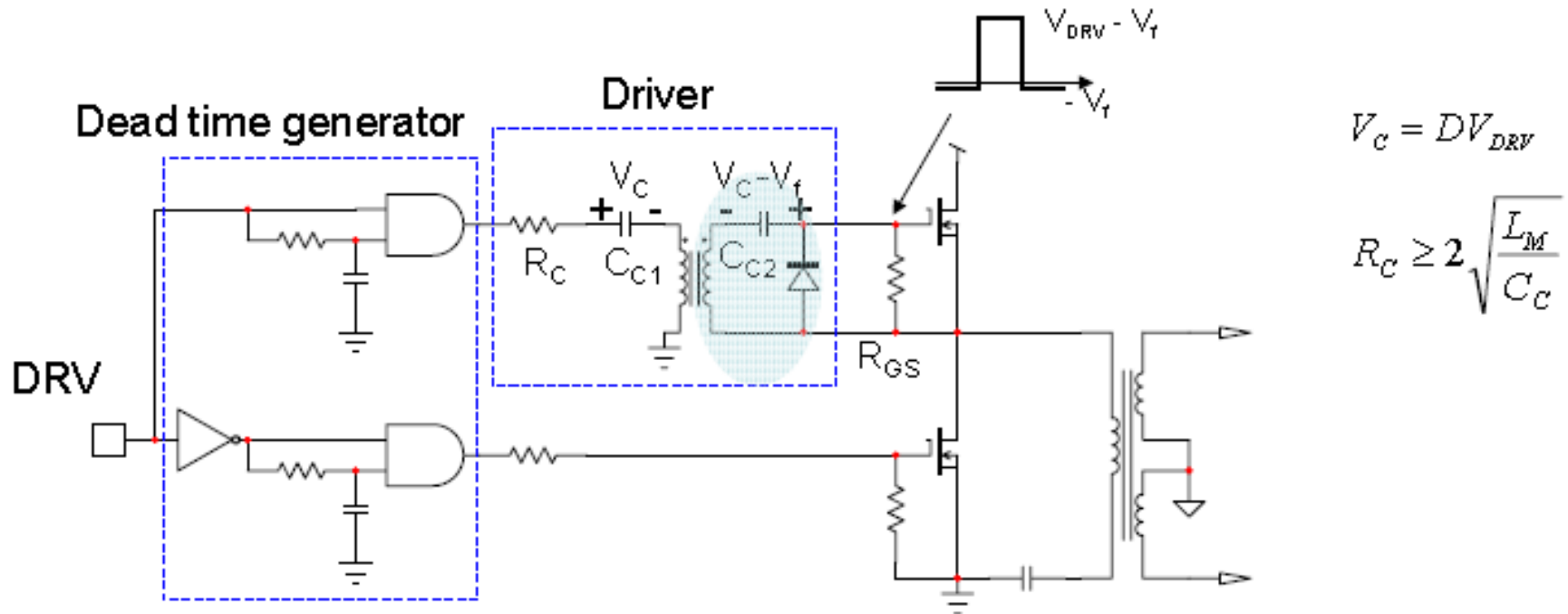
$$R_C \geq \frac{1}{Q} \sqrt{\frac{L_M}{C_C}} = 2 \sqrt{\frac{L_M}{C_C}}$$

C_C to reset the driver transformer and R_C to damp the L - C resonance.

- An ac coupling capacitor (C_C) is needed to reset the driver transformer flux.
- The amplitude of V_{GS} is dependent on duty. ☹
- With $(-V_C)$ to turn off at steady state, but the sink capability is limited at start-up. ☹
- Need a fast time constant ($L_M / R_{GS} * C_C$) to avoid flux walking due to the fast transient.
- Watch out the ringing between C_C and drive transformer at skip mode or UVLO, a diode is needed to damp the ringing.

Obnovitel stejnosměrné složky za oddělovacím transformátorem

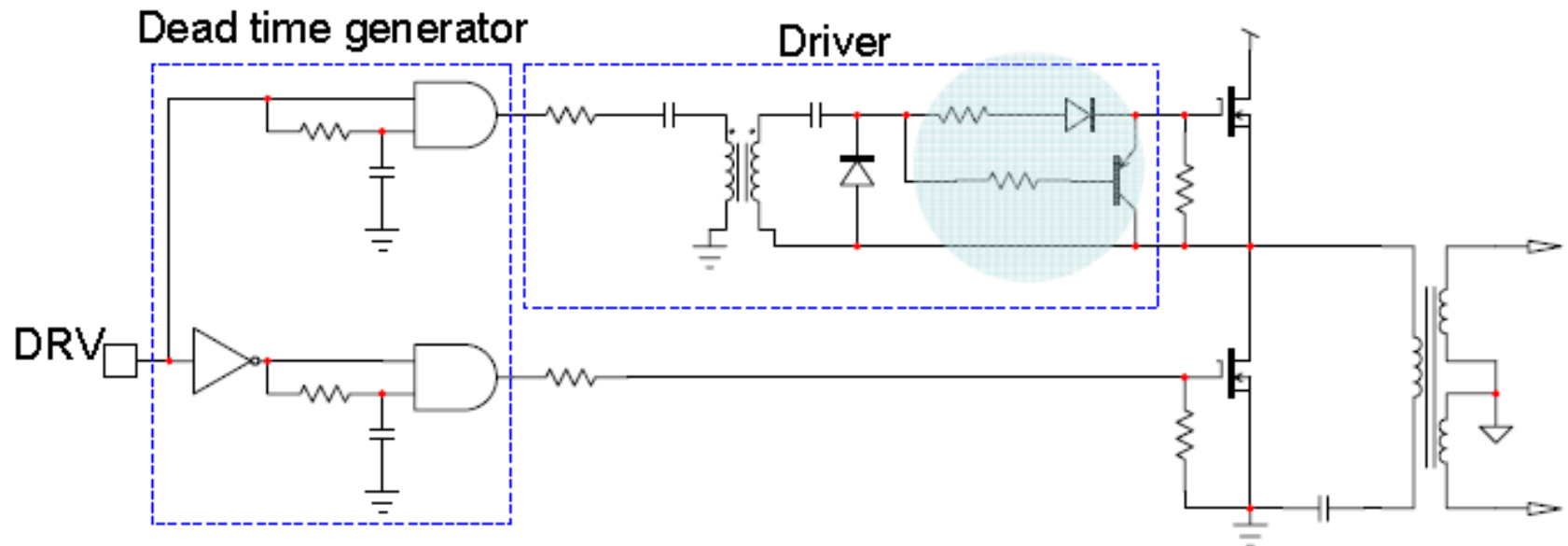
Single DRV Input with DC Restore



- V_{GS} amplitude is independent on duty ratio at steady state. 😊
- Limited sink capability. 😞

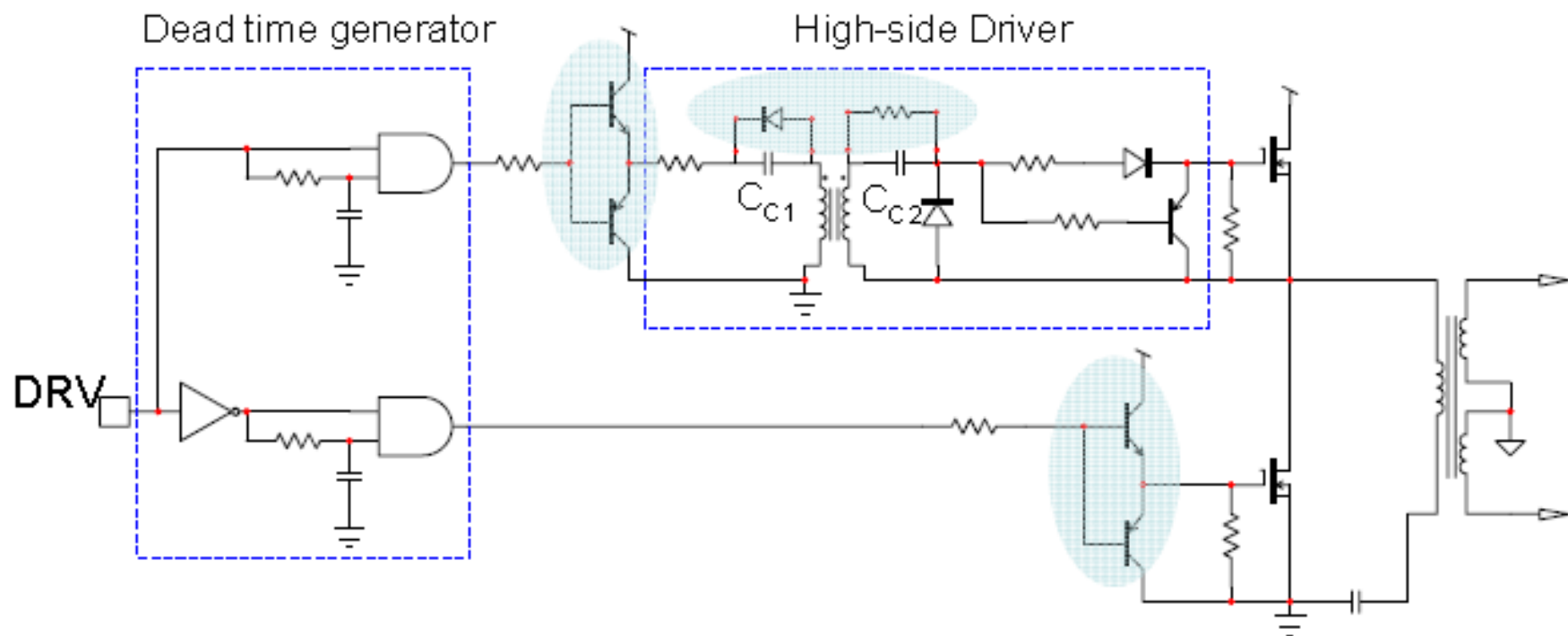
Zrychlení vypnutí spínače PNP tranzistorem

Single DRV Input with PNP Turn-Off



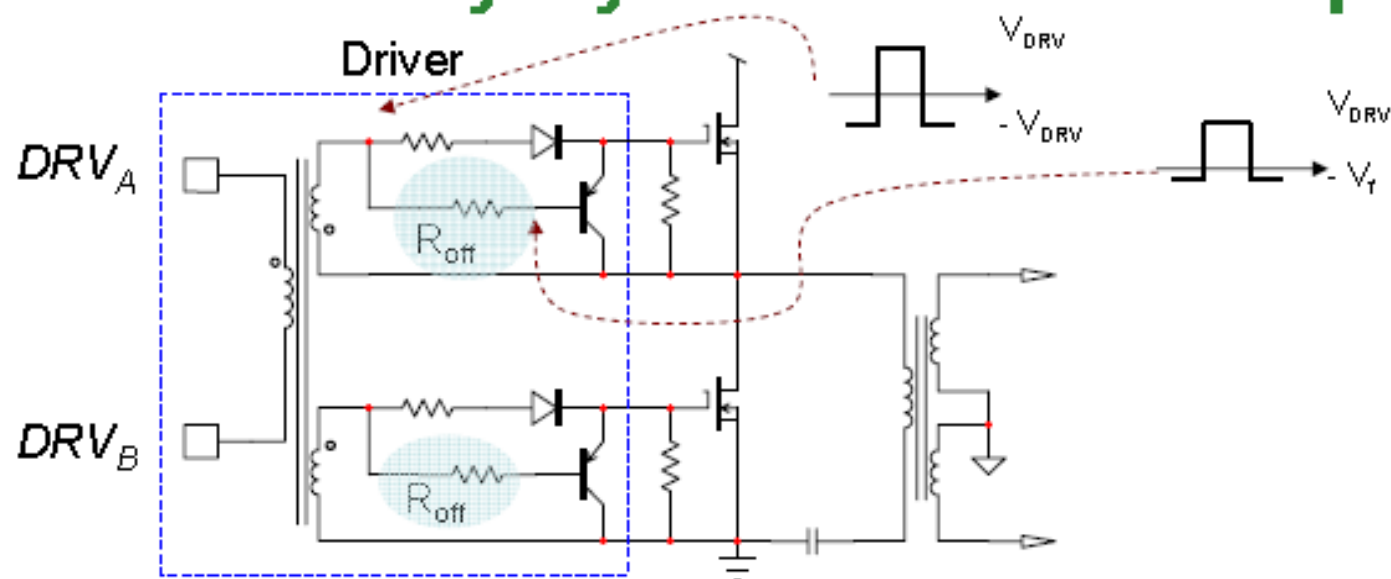
- A pnp transistor + diode help to improve the switching off.

Přidání proudového budiče za generátor pulzů



- Add the totem-pole drivers if output capability of AND gate is limited.
- Is the design finished?
 - ➔ No, not yet. Pay attention to the ringing among C_{C1} , C_{C2} and driver transformer when skip or UVLO. A diode and resistor to damp the ringing. ☹

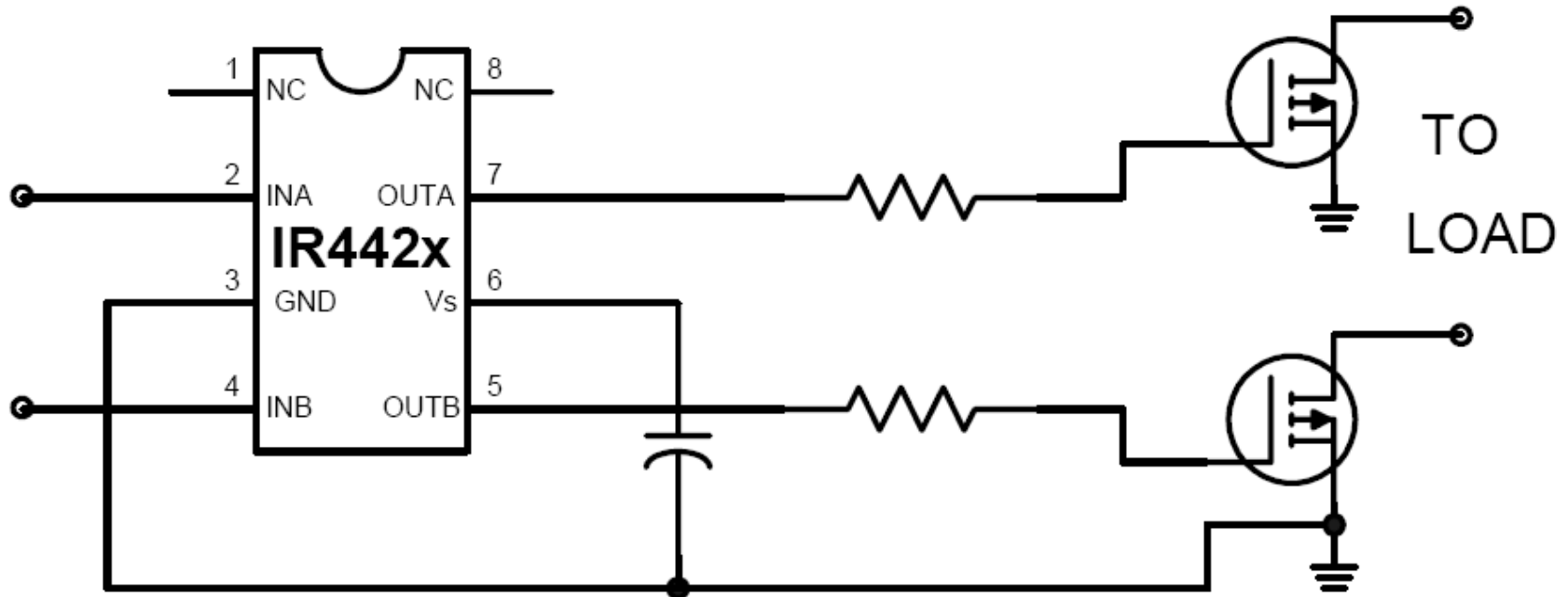
Dual Polarity Symmetrical DRV Inputs



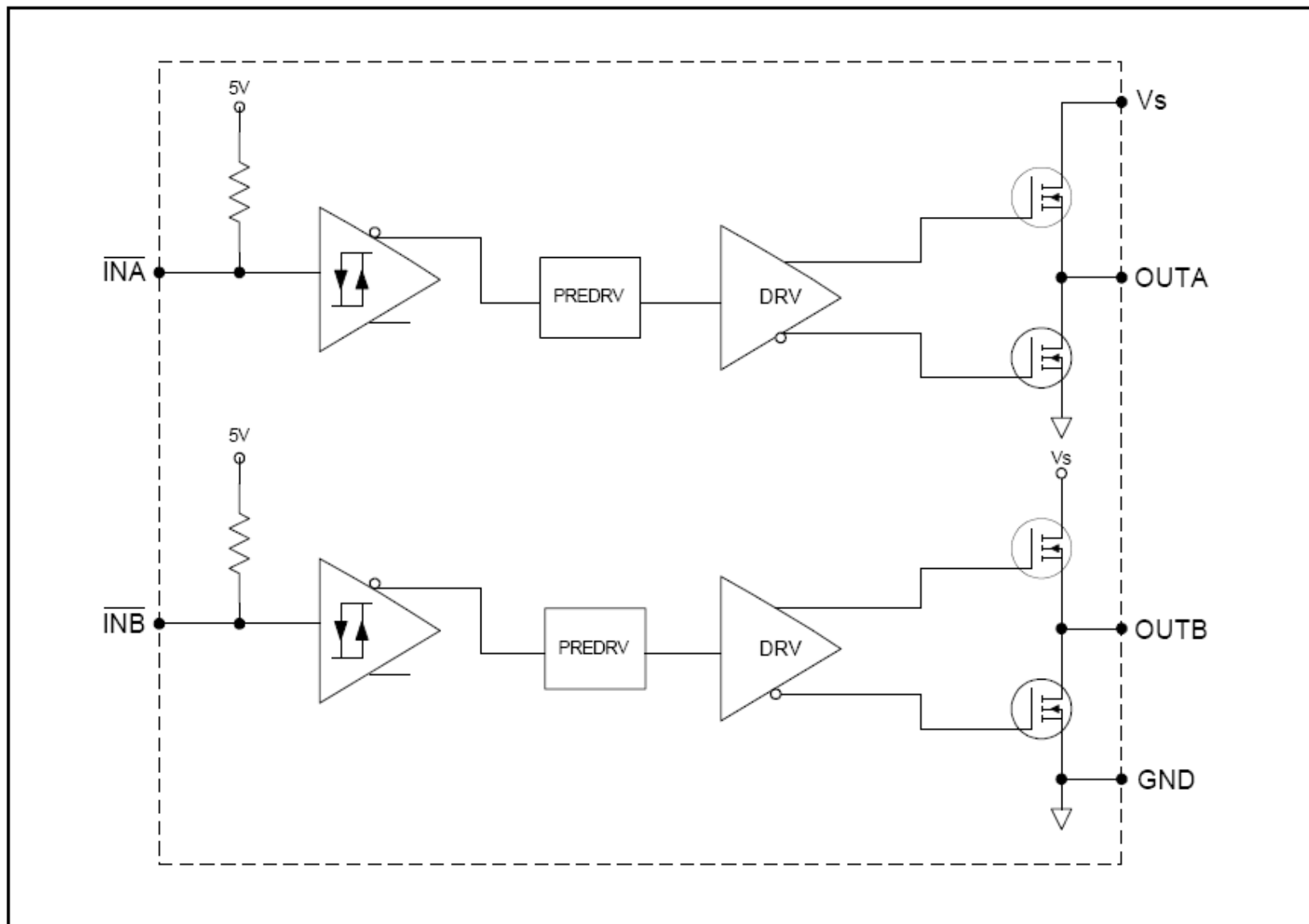
- DRV_A and DRV_B are opposite-polarity and symmetrical → no ac coupling capacitor. 😊
- This is suitable for push-pull type circuit, e.g. LLC-HB, but NOT for asymmetrical type, e.g. AHB or active clamp. ☹️
- Pay attention to the flux of driver transformer at line/load transient.
- The strong turn off capability is still needed. ☹️
- Pay attention to the delay caused by the leakage inductance. → minimize the leakage inductance and use dual output windings instead of single output winding.
- Extra losses caused by voltage drop on R_{off} . ☹️

Budiče pro IGBT a MOSFET spínače.

- integrované budiče schopné budit efektivně vstup IGBT/MOSFET tranzistoru
- musí být schopné dodat velký proud v pulzu na nabití kapacity C_{GE}

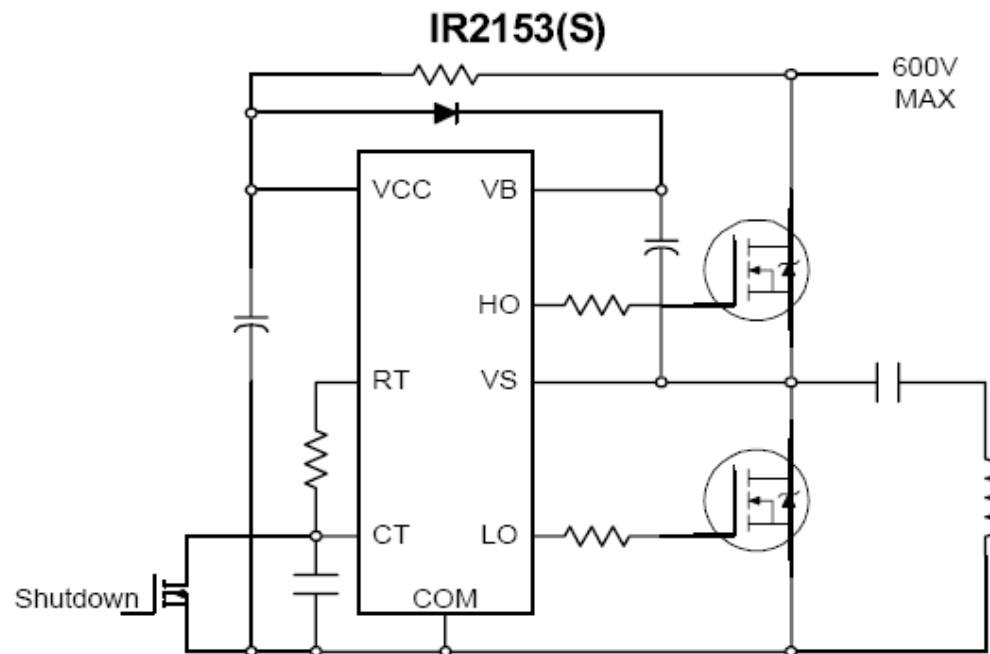


Vnitřní schéma budiče IR4426

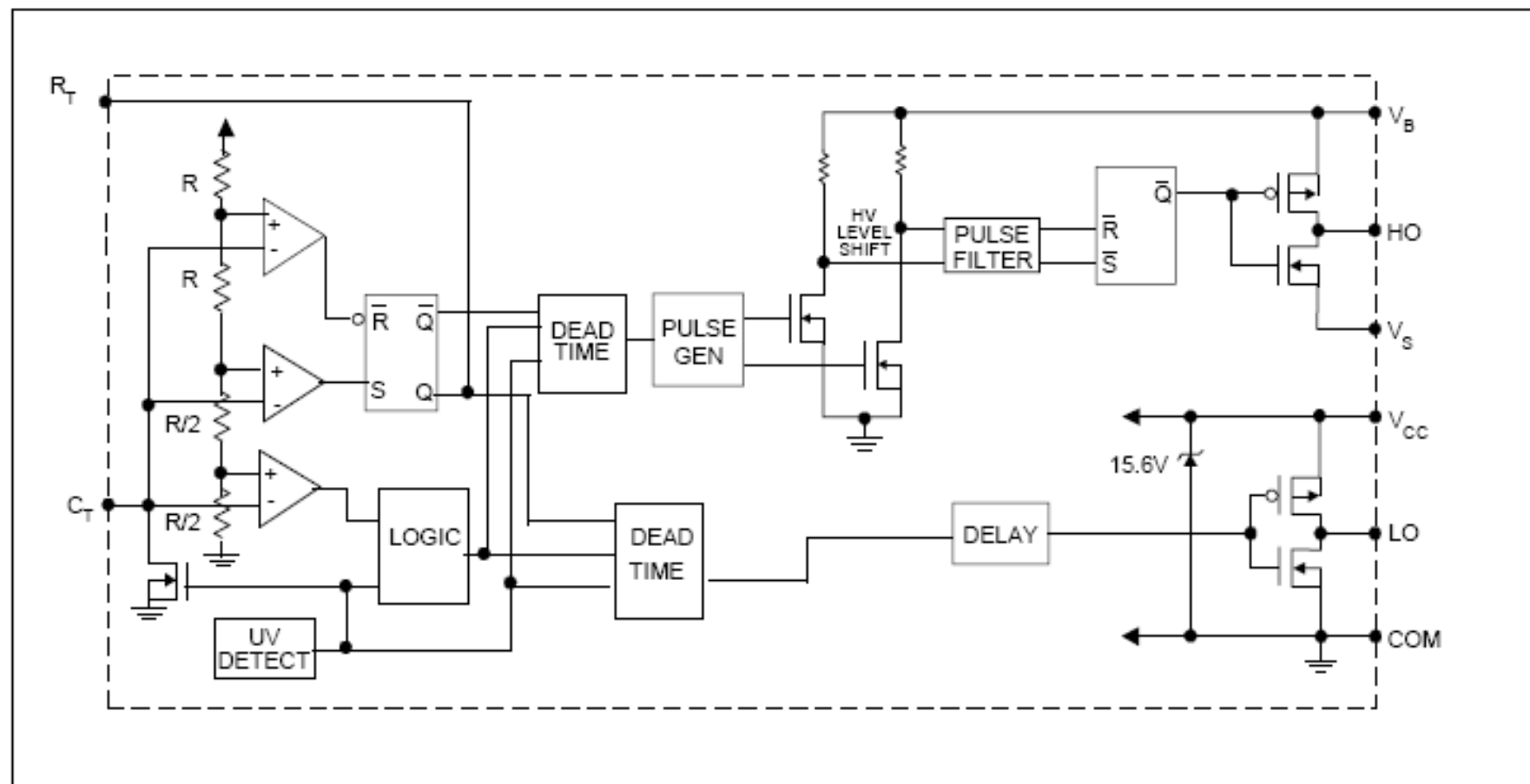


HIGH AND LOW SIDE DRIVER

-spíná střídavě horní a dolní MOSFET/IGBT

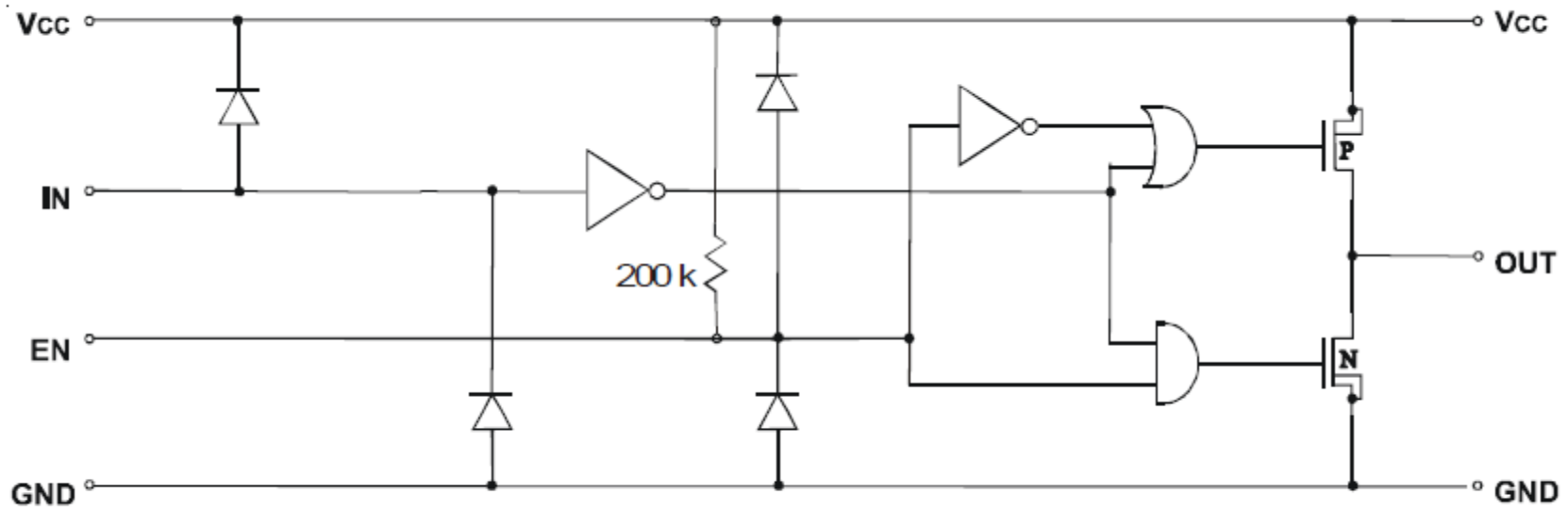


Functional Block Diagram for IR2153(S)



IXDD414PI / 414YI / 414CI / 414SI

14 Amp Low-Side Ultrafast MOSFET Driver



Metoda zrychlení vypnutí

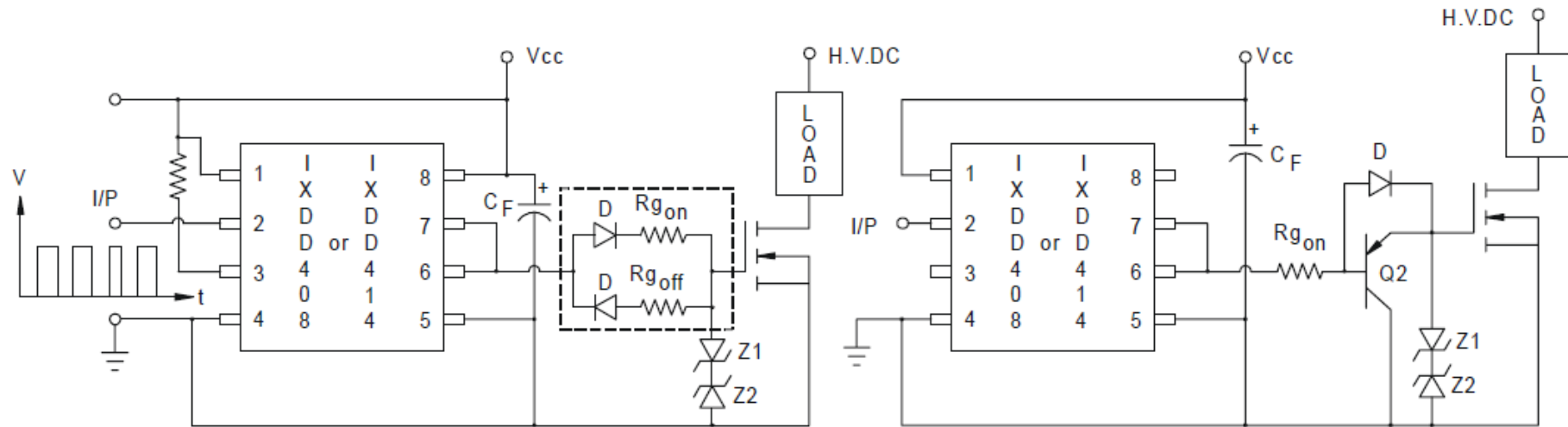


Fig (13) Turn-off enhancement methods.

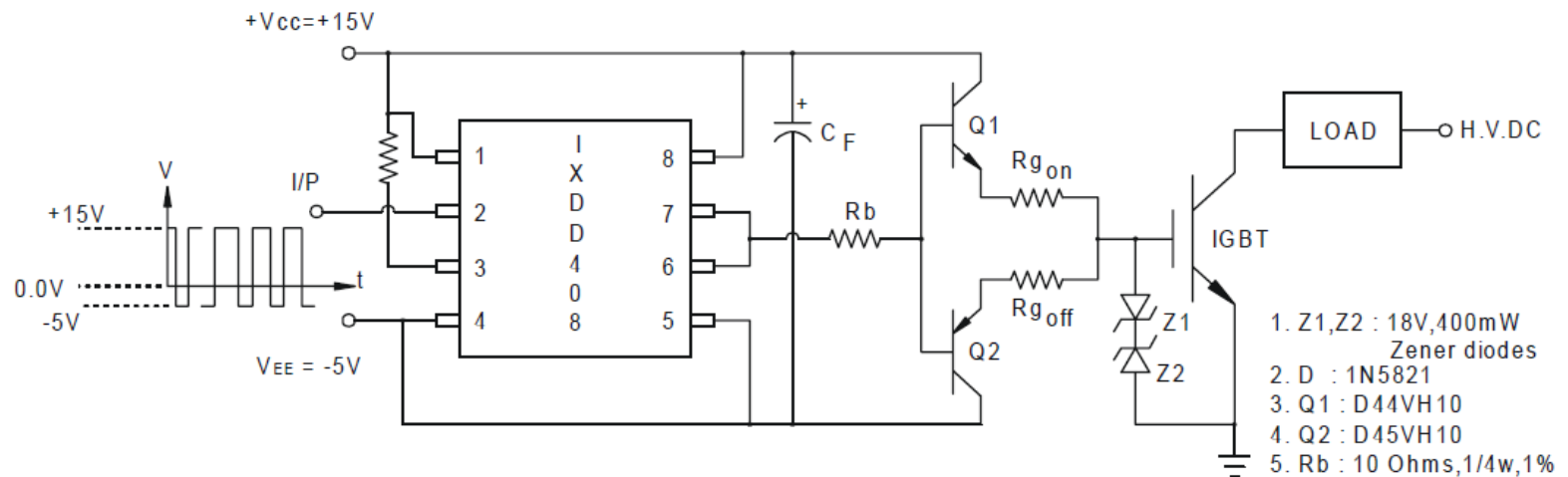


Fig. (14). Technique to boost current output and provide -ve bias to achieve faster turn off for high power MOSFET and IGBT Modules

Budiče s oddělovacími transformatory

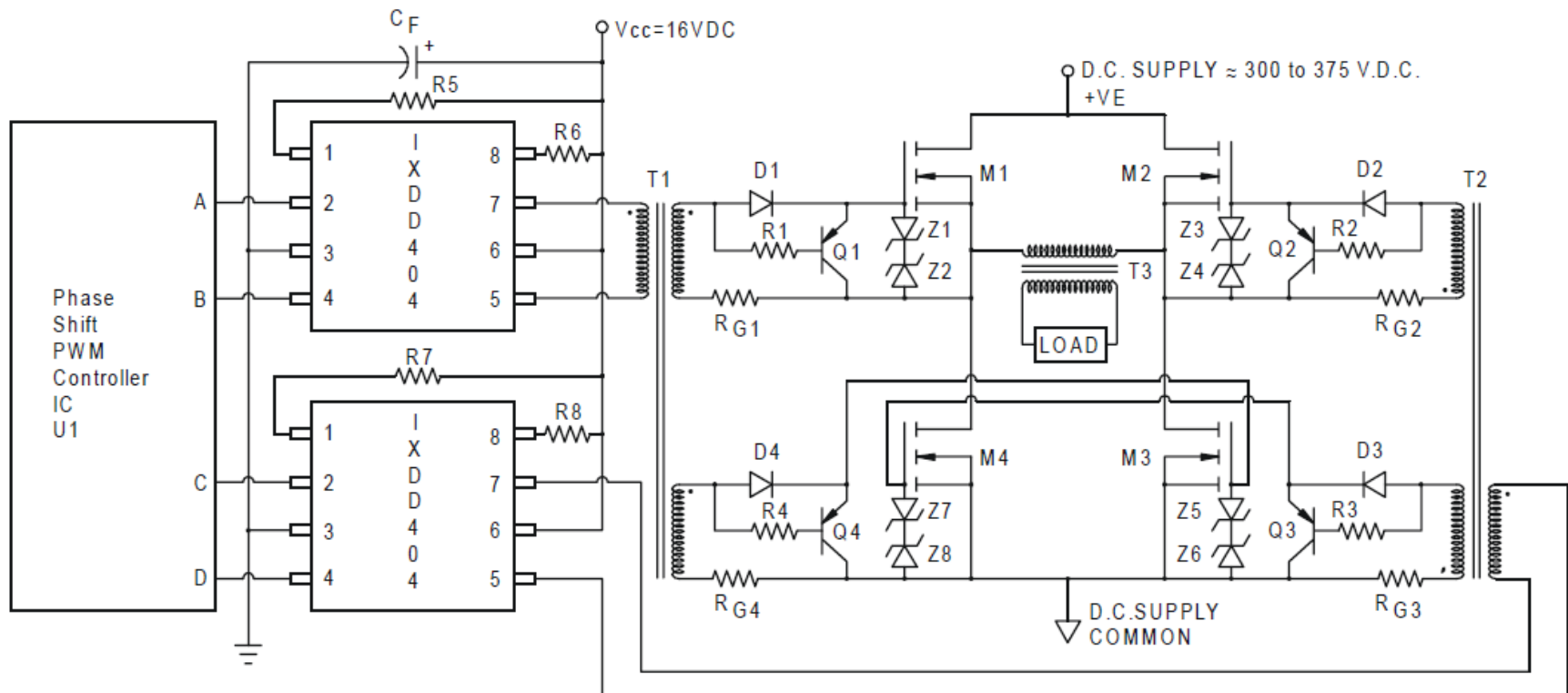


Fig. (15) Transformer coupled Gate Drive arrangement for "H" Bridge in a Phase Shift PWM Controller at fixed Switching frequency.

Spínané zdroje

- moderní a efektivní řešení
- možnost použít transformace na vysoké frekvence
- vysoké frekvence spínání → malé rozměry transformátoru, malé filtrační kapacity
- používá se pulzně šířková modulace se zpětnou vazbou pro regulaci a stabilizaci výstupního napětí nebo proudu případně výkonu

základní uspořádání

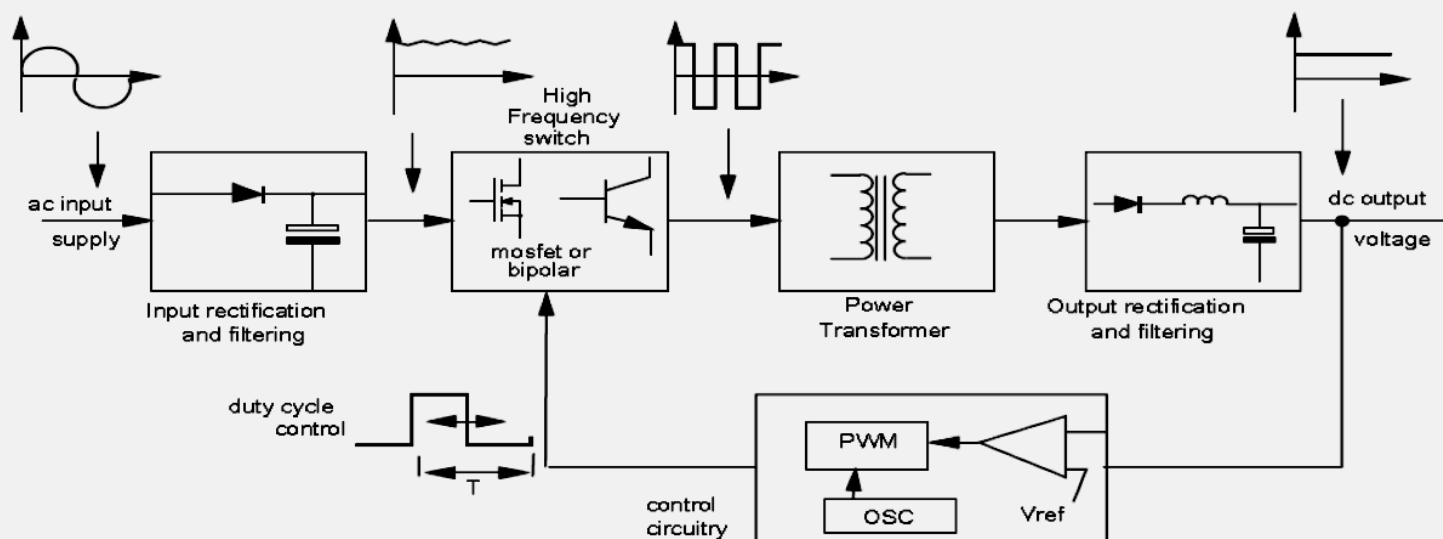


Fig. 1. Basic switched mode power supply block diagram.

Literatura:

A.Frohn, W. Oberthur, H. Siedler, M. Wiemer, P. Zastrow, Elektronika-Polovodičové součástky a základní zapojení, BEN Praha 2006.

Jens Peer Slengl, Jeno Tihanyi, Výkonové tranzistory MOSFET, BEN - technická literatura, Praha 1999.